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# (54) EDGE TYPE BACKLIGHT UNIT AND METHOD FOR MANUFACTURING THE SAME

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(58) Field of Classification Search

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#### (57) ABSTRACT

An edge type backlight unit and a method for manufacturing the same are disclosed. The edge type backlight unit includes light sources for providing light, a printed circuit board (PCB) on which the light sources are mounted, a metal bracket that contacts the printed circuit board and dissipates heat of the printed circuit board, and a thermal hardener formed between the printed circuit board and the metal bracket. The printed circuit board supplies an electrical signal for driving the light sources to the light sources.

## 10 Claims, 11 Drawing Sheets

